

# **POC-500 Series**

AMD Ryzen™ V1000 Ultra-compact Embedded Controller with 4x PoE+, 4x USB 3.0 and MezIO™ Interface





#### Key Features

- · AMD Ryzen™ embedded V1000 series quad-core 15W/ 45W CPU
- · -25 °C to 70 °C rugged wide-temperature operation
- · Four Gigabit PoE+ ports with screw-lock
- · Four USB 3.0 ports with screw-lock
- · M.2 2280 M key NVMe (Gen3 x4) socket for fast storage access
- · DVI + VGA dual display outputs
- · Front I/O access and DIN-rail mounting design
- MezIO<sup>™</sup> compatible

#### Introduction

POC-500 series is the next generation ultra-compact embedded controller offering performances never-seen-before in this form factor. Featuring AMD Ryzen™ Embedded V1000 4-core/ 8-thread processor, it delivers up to 3x times the CPU performance over previous POC series. GPU performance wise, it delivers an unheard of 3.6 TFLOPS in FP16 for an ultra-compact form factor embedded controller. Another amazing feat is that it manages to incorporate an M.2 2280 NVMe SSD to support 4x times the disk read/ write speed over typical 2.5" SATA SSDs.

POC-500 series continues the POC series ingenious DIN-rail mounting mechanical design and offers plenty of front-accessible I/Os. Measuring just 63 x 176 x 116 mm (2.5" x 6.9" x 4.6"), it has 4x PoE+ ports, 4x USB 3.0 ports and 4x COM ports. And best of all, all data ports come with screw-lock mechanism so you can be rest assured that cables are always secured. POC-500 series is available in two CPU variants, the V1807B (45W) variant is for high computing power demand and the V1605B (15W) variant is designed for rugged fanless operation.

The arrival of POC-500 series signifies a new breed of ultra-compact embedded controller; one with better I/O design, extraordinary ruggedness and significantly more CPU/ GPU oomph for versatile applications.

### **Specifications**





	POC-515	POC-545	
System Core			
Processor	AMD Ryzen™ V1605B CPU ( 4C/ 8T, 2M Cache, 2.0/ 3.6 GHz, 12W - 25W TDP)	AMD Ryzen™ V1807B CPU (4C/ 8T, 2M Cache, 3.35/ 3.8 GHz, 35W - 54W TDP)	
Graphics	Vega GPU with 8 compute units	Vega GPU with 11 compute units	
Memory	Up to 16 GB DDR4-2400 SDRAM by one SODIMM socket	Up to 16 GB DDR4-3200 SDRAM by one SODIMM socket	
Panel I/O Interface			
Ethernet	4x Gigabit Ethernet ports by Intel® 1350-AM4 controller with screw-lock		
PoE+	IEEE 802.3at PoE+ on port #1~ 4		
USB	4x USB 3.0 ports with screw-lock		
Video Port	1x VGA connector, supporting 1920 x 1200 resolution 1x DVI-D connector, supporting 1920 x 1200 resolution		
Serial Port	1x software-programmable RS-232/ 422/ 485 ports (COM1) 3x 3-wire RS-232 ports (COM2/ 3/ 4) or 1x RS-422/ 485 port (COM2)		
Audio	1x 3.5mm jack for mic-in and speaker-out		
Internal I/O Int	Internal I/O Interface		
Mini-PCIe	1x full-size mini PCI Express socket with internal SIM socket		
Expandable I/O	1x MezlO <sup>™</sup> expansion interface for Neousys MezlO <sup>™</sup> modules		
Storage Interface			
M.2 NVMe	1x M.2 2280 M key NVMe socket (PCIe Gen3 x4) for NVMe SSD installation		



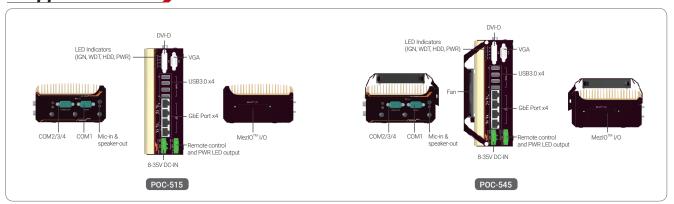


	POC-515	POC-545
Power Supply		
DC Input	1x 3-pin pluggable terminal block for 8~35VDC DC input	
Remote Ctrl.&LED Output	1x3-pin pluggable terminal block for remote control and PWR LED output	
Mechanical		
Dimension	63 (W) x 116 (D) x 176 (H) mm	81 (W) x 118 (D) x 176 (H) mm
Weight	1.2 kg	1.4 kg
Mounting	DIN-rail mount (standard) or wall-mount (optional)	
Fan	-	External-accessible 80mm x 80mm fan for system heat dissipation
Environmental		
Operating Temperature	-25°C ~ 70°C*/**	
Storage Temperature	-40°C ~85°C	
Humidity	10%~90% , non-condensing	
Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4	
Shock	Operating, MIL-STD-810G, Method 516.6, Procedure I, Table 516.6-II	
EMC	CE/ FCC Class A, according to EN 55032 & EN 55024	

<sup>\*</sup> For sub-zero operating temperature, a wide temperature HDD or Solid State Disk (SSD) is required. \*\* For POC-545, operating temperature is up to 70°C only if external-accessible fan is installed



#### **Appearance**



### **Dimensions**



## **Ordering Information**

Model No.	Product Description
POC-515	AMD Ryzen™ V1605B ultra-compact embedded controller with 4x PoE+ ports, 4x USB 3.0 ports and MezlO™ interface
POC-545	AMD Ryzen™ V1807B ultra-compact embedded controller with 4x PoE+ ports, 4x USB 3.0 ports and MezlO™ interface

## **Optional Accessories**

PA-120W-OW	120W AC/DC power adapter 20V/6A; 18AWG/120cm; cord end terminals for terminal block, operating temperature : -30 to 70 °C.	
PA-60W-OW	60W AC/DC power adapter with 12V, 5A DC output, cord end terminals for terminal block. operating temperature : $-30 \text{ to } 60 ^{\circ}\text{C}$ .	
Cbl-DB9F-3DB9M-10CM	1x DB9 (Female) to 3x DB9 (Male), length: 10CM	
MezIO™ Modules		
MezIO <sup>™</sup> -C180	MezIO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-232 ports	
MezIO <sup>™</sup> -C181	MezIO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-422/ 485 ports	
MezIO <sup>™</sup> -D220	MezIO™ module with 8-CH isolated digital input and 8-CH isolated digital output	
MezIO <sup>™</sup> -D230	MezIO™ module with 16-CH isolated digital input and 16-CH isolated digital output	
MezIO <sup>™</sup> -V20	MezIO™ module with ignition power control function and 1x mini-PCle socket for in-vehicle usage	
MezIO <sup>™</sup> -U4	MezIO™ module with 4x USB3.0 ports	
MezIO <sup>™</sup> -R11	MezIO™ module with SATA port for 2.5" HDD/ SSD	
MezIO <sup>™</sup> -R12	MezIO™ module with SATA port for 2.5" HDD/ SSD, 4-CH isolated DI and 4-CH isolated DO	